

ELECTROPLATED EDGE GRINDING WHEEL



Advantages

- Minimized product-to-product variation through stringent diamond grit distribution control
- Superior cutting quality through optimized configuration of diamond grit size and concentration
- 50% Longer wheel life time compared to competitor's wheel
- Dual diamond mesh (for rough & fine grinding)

Application

LCD Panel, OLED Panel, Smart Phone Cover glass, Sapphire and Silicon wafer edge grinding



Available Product Spec.

Type	Diameter	Grit size	Bond type
ED - DW	$\Phi 0.5 \sim \Phi 100$	#100 ~ #1500	plating
ED - 1FF6Y	$\Phi 20 \sim \Phi 300$		

EHWA DIAMOND IND. CO. LTD.

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EHWA DIAMOND

SEMICONDUCTOR / DISPLAY / SOLAR & LED



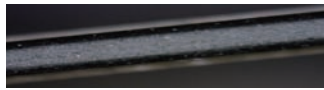
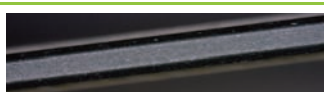
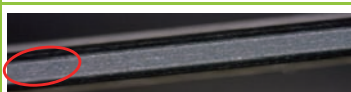
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Performance Data

	EHWA	Competitor's
325 Mesh		
400 Mesh		
600 Mesh		
800 Mesh		
1000 Mesh	